1Q FY2016 (April 1, 2015 – June 30, 2015)

Financial Announcement

Agenda:

- Introduction
 Tetsuro Higashi, Representative Director, President & CEO
- ➤ 1Q FY2016 Consolidated Financial Summary
 Tetsuro Hori, Corporate Director, Senior Vice President & General Manager
- Business Environment and Revision of Financial Estimate Toshiki Kawai, Representative Director, Senior Executive Vice President & COO

July 28, 2015



1Q FY2016 Consolidated Financial Summary

1Q FY2016: April 1, 2015 - June 30, 2015 FY2016: April 1, 2015 - March 31, 2016

Tetsuro Hori Corporate Director, Senior Vice President & General Manager

July 28, 2015

FY2016 1Q Highlights

- Announced Medium-term Management Plan
 New shareholder return policy to raise dividend payout ratio to 50%
- 2. Achieved 42% of gross profit margin and 19% of operating profit margin
- 3. Revised financial estimates to reflect market adjustment

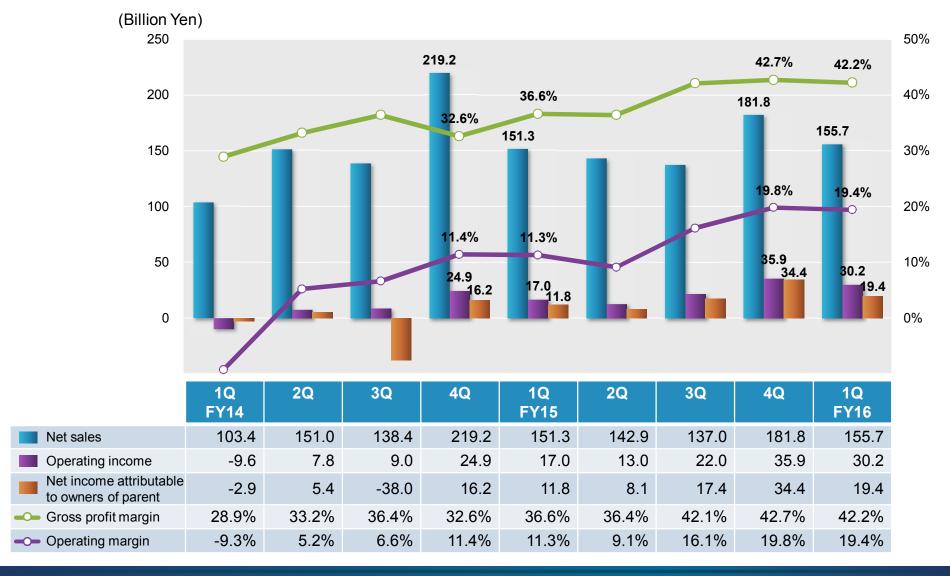
Financial Summary

	(Billion Yen)					
		FY2	FY2016			
	1Q	2Q	3Q	4Q	1Q	vs. 1Q FY2015
Net sales	151.3	142.9	137.0	181.8	155.7	+2.9%
Gross profit Gross profit margin	55.3 36.6%	52.0 36.4%	57.6 42.1%	77.6 42.7%	65.7 42.2%	+18.6% +5.6pts
SG&A expenses	38.3	39.0	35.5	41.7	35.4	-7.5%
Operating income Operating margin	17.0 11.3%	13.0 9.1%	22.0 16.1%	35.9 19.8%	30.2 19.4%	+13.2 +8.1pts
Income before income taxes	15.0	14.0	24.7	32.9	29.0	+14.0
Net income attributable to owners of parent	11.8	8.1	17.4	34.4	19.4	+7.6
R&D expenses	16.7	18.1	16.8	19.5	17.5	+4.9%
Capital expenditures	3.7	3.5	2.6	3.2	2.1	-41.9%
Depreciation and amortization	4.7	5.0	5.4	5.6	4.6	-2.0%

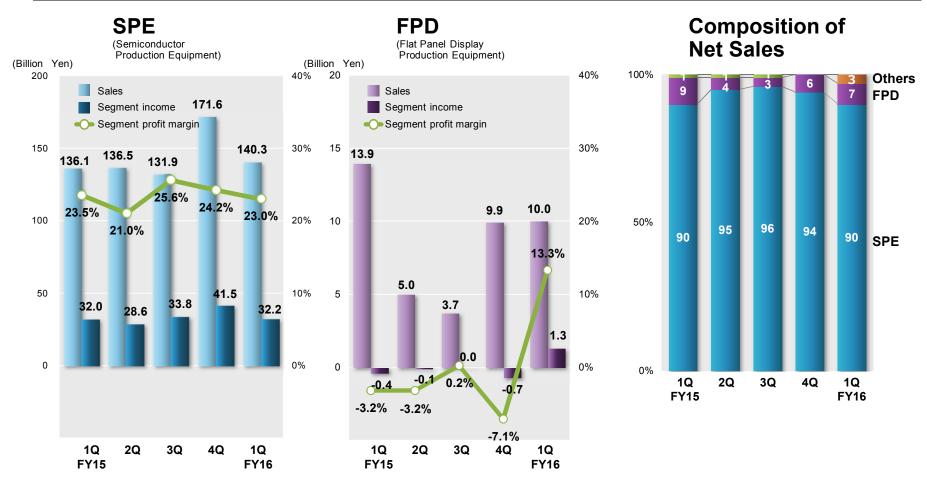
^{1.} In principle, export sales of Tokyo Electron's mainstay semiconductor and FPD production equipment are denominated in yen. While some settlements are denominated in dollars, exchange risk is hedged as forward exchange contracts are made individually at the time of booking.

^{2.} Profit ratios are calculated using full amounts, before rounding.

Financial Performance

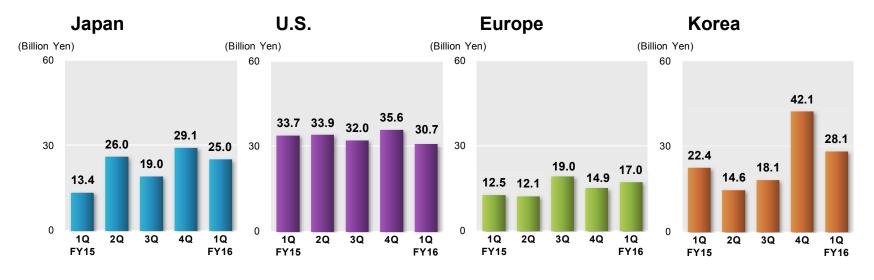


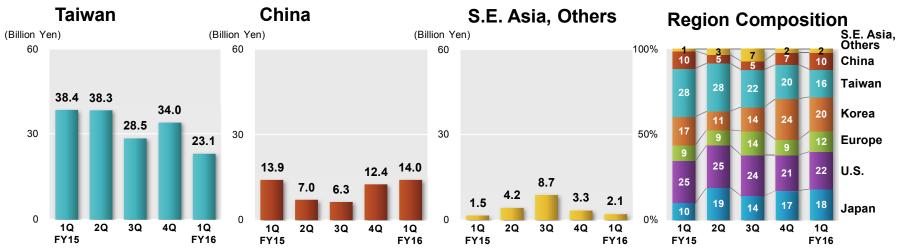
Segment Information



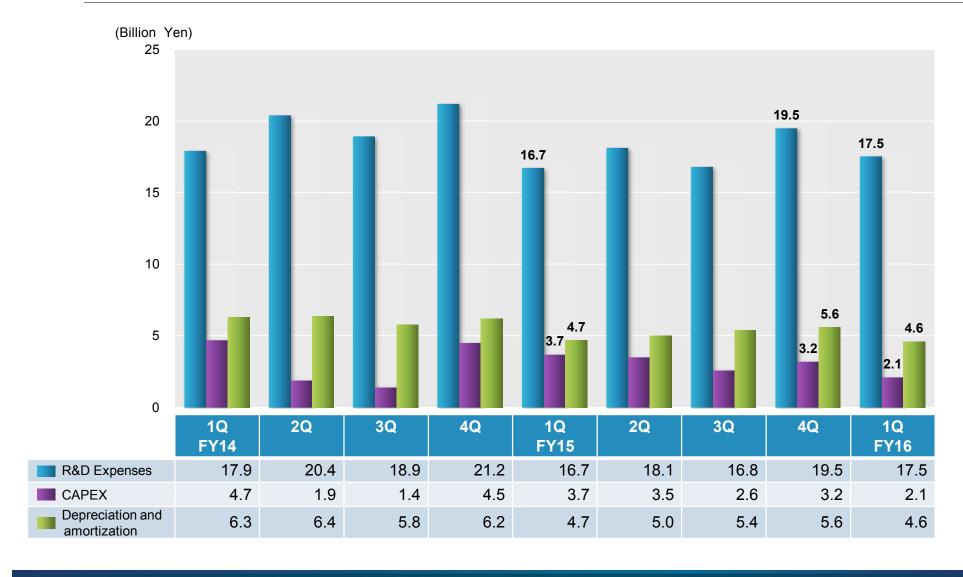
- 1. Segment income is based on income before income taxes.
- 2. R&D expenses such as fundamental research and element research are not included in above reportable segments.
- 3. From 1Q FY2016, due to its reduced importance the PV production equipment business has been excluded from segmental reporting.

SPE Sales by Region





R&D, CAPEX and Depreciation Expenses

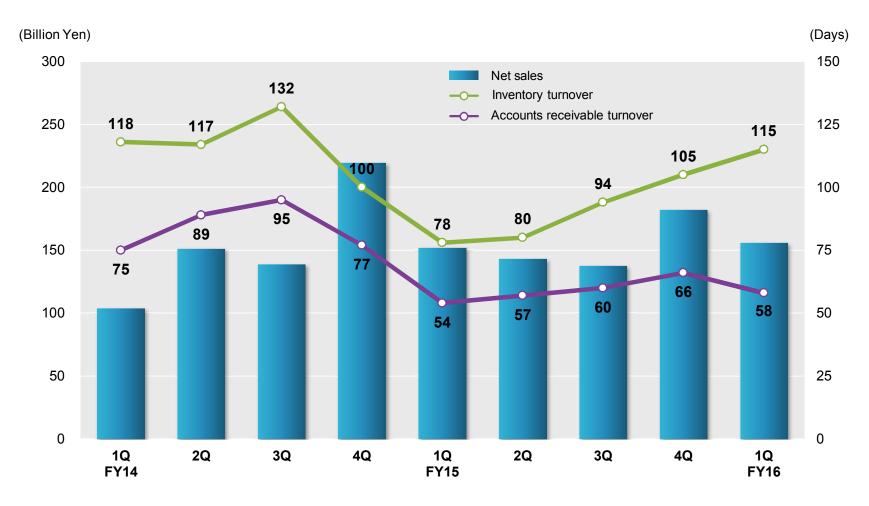


Balance Sheet

Assets Liabilities & Net Assets (Billion Yen) (Billion Yen) 876.1 876.1 841.9 841.9 831.5 831.5 801.3 801.3 768.7 768.7 234.9 214.5 Other liabilities 218.4 317.6 205.4 285.3 298.9 Cash & cash equivalents* 182.1 299.1 280.0 Trade notes, accounts 110.8 97.9 106.5 receivables 102.0 97.4 166.9 175.5 194.8 Inventories 142.2 141.1 641.1 627.3 Net assets 613.1 595.8 586.6 59.5 66.7 49.7 43.0 48.5 Other current assets 111.6 111.7 110.6 106.8 105.3 Tangible assets 29.1 26.8 27.6 27.5 27.1 Intangible assets 69.1 Investment & other assets 69.5 68.7 72.1 70.8 1Q 2Q 3Q 4Q 1Q 1Q 2Q **3Q** 4Q 1Q FY15 **FY16** FY15 **FY16**

^{*}Cash and cash equivalents: Cash and deposits + Short-term investments, etc. (Securities in B/S).

Inventory Turnover and AR Turnover



Turnover days = Inventory or AR at the end of each quarter / last 12 months sales x 365

Cash Flow



^{*}Cash flow from investing activities excludes changes in deposits with periods to maturity of over 3 months.

^{**}Free cash flow = cash flow from operating activities + cash flow from investing activities excluding changes in deposits with periods to maturity of over 3 months.

^{***}Cash on hand includes the total of cash + deposits with periods to maturity of over 3 months.

Share Repurchase Status

Cumulative total of shares repurchased (as of June 30, 2015)

(1) Total number of shares acquired: 3,111,900 shares

(2) Total cost of acquisition: 23,838,423,989 yen

Details of announcement on April 27, 2015

☐ Type of shares to be acquired: Shares of common stock

□ Total number of shares to be acquired: Up to 15.4 million shares

(Equivalent to 8.59% of outstanding shares excluding treasury stock)

☐ Total cost of acquisition: Up to 120 billion yen

■ Period of acquisition:
From May 14, 2015 to May 13, 2016

Business Environment and Revisionof Financial Estimates

Toshiki Kawai
Representative Director, Senior Executive Vice President & COO
July 28, 2015



Business Environment

SPE Capex

CY2015 WFE capex is expected to increase slightly YonY driven by demand from the enterprise server and mobile device markets

- DRAM/NAND: Increase YonY due to investment in increased production
- Foundry: Continued investment in 1X generation cutting-edge logic
- Logic: Server and image sensor demand strong but PC demand weakening, overall logic expected to show YonY decline

FPD Capex

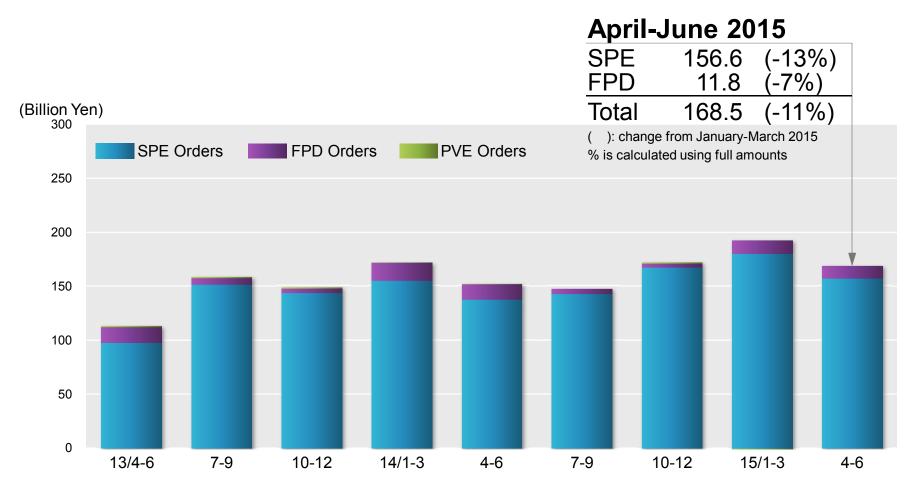
CY2015 demand for LCD panel manufacturing equipment forecast to increase 20% YonY due to increase in capex for large panels and the start of investment in small/medium panels for mobile devices.

OLED TV market expected to develop from 2017

(Outlook as of July 2015)

The semiconductor production process can be divided into two sequential sub-processes referred to as front-end (wafer fabrication) and back-end (assembly and test) production. WFE (wafer fabrication equipment) is used in the front-end production process.

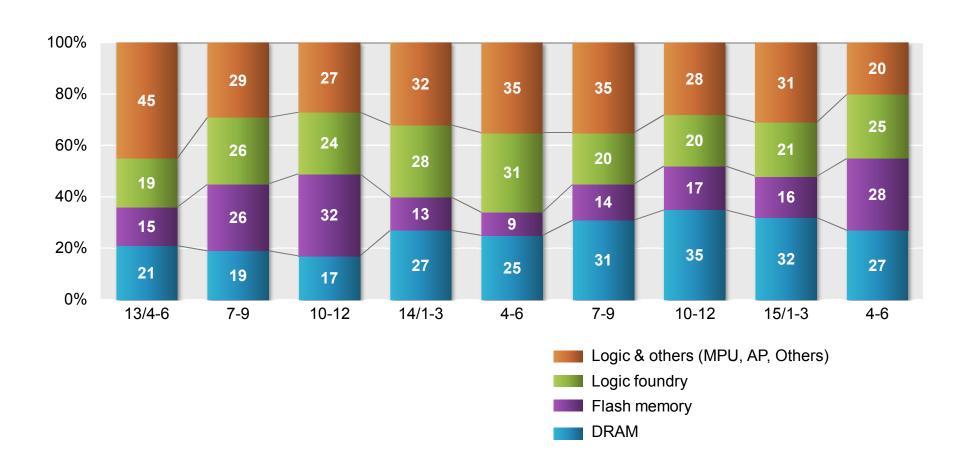
Quarterly Orders



From the April-June 2015 quarter, due to its reduced importance the PVE business has been excluded from segmental reporting.

Composition of SPE Orders by Application:

Equipment only



SPE Orders by Region



Orders, Order Backlog



From the 2015/4-6 quarter, due to its reduced importance the PVE business has been excluded from segmental reporting.

Revision of FY2016 Financial Estimates



Revision of FY2016 Financial Estimates

> Revised estimates to reflect market adjustment

(Billion Yen)

		FY2016 (Estimate)						
	FY2015	1 st half		2 nd half		Full year		YonY
		New estimates	Adjust- ments*	New estimates	Adjust- ments*	New estimates	Adjust- ments*	change
Net sales	613.1	338.5	+18.5	306.5	-48.5	645.0	-30.0	+5%
SPE	576.2	315.0	+15.0	279.0	-46.0	594.0	-31.0	+3%
FPD	32.7	18.0	+0.5	27.0	-2.5	45.0	-2.0	+38%
Operating income Lower line: OP margin	88.1 14.4%	53.5 15.8%	+6.5 +1.1pts	41.5 13.5%	-23.5 -4.8pts	95.0 14.7%	-17.0 -1.9pts	+6.9 +0.3pts
Income before income taxes	86.8	52.5	+6.5	41.5	-23.5	94.0	-17.0	+7.2
Net income attributable to owners of parent	71.8	37.0	+4.0	29.0	-17.0	66.0	-13.0	-5.8

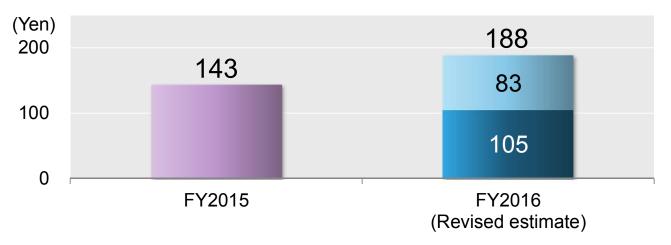
^{*}Adjustments: changes from the figures announced on April 27, 2015.

SPE: semiconductor production equipment FPD: flat panel display production equipment

FY2016 Dividend Forecast

New shareholder return policy: Raise dividend payout ratio to 50%, plan to pay high dividend of 188 yen





Our previous dividend policy since FY2011 year-end dividend was performance-linked payout ratio of around 35%.

Medium-term Management Plan Highlights



Financial Model (toward FY2020)

Aiming for global-level profitability

(Billion Yen)

	FY2016 (Estimate)	FY2020 (Medium-term plan)		
	WFE \$33B	WFE \$30B	WFE \$37B	
Net sales	645.0	720.0	900.0	
Gross profit margin	38%	42%	44%	
SG&A expenses SG&A expense ratio	149.0 23%	160.0 22%	170.0 19%	
Operating margin	15%	20%	25%	
ROE		15%	20%	

The semiconductor production process can be divided into two sequential sub-processes referred to as front-end (wafer fabrication) and back-end (assembly and test) production. WFE (wafer fabrication equipment) is used in the front-end production process.

Medium-term Plan: Basic Strategy

- 1. Outperform market growth
 - Focus on SPE growth areas: Etching, ALD and Cleaning
 - > Strengthen Field Solutions business
- 2. Pursue operational efficiency
 - Raise efficiency of development and manufacturing
 - Reduce SG&A expense/Sales ratio

Increase market share and profitability by providing high value added products.

Grow sales while limiting associated cost increases

Medium-term Market Outlook

- 1. Internet of Things (IoT) will expand semiconductor applications and markets
- 2. At technological inflection points, extensive new technologies will drive semiconductor evolution
 - Advanced patterning technologies
 - > 3D devices, new materials and new structure
 - New memory (STT-MRAM)

WFE market expected to grow in medium-term

STT-MRAM: Spin Transfer Torque-Magnetoresistive Random Access Memory

Medium-term Main Scenario (WFE \$37B)

Net sales 900 billion yen (+40%)

Gross profit margin 44% (+6%pts)

SG&A expense ratio 19% (-4%pts)

Operating margin 25% (+10%pts)

(): comparison between FY2016 financial estimates and each target in medium-term plan.

▶ Disclaimer regarding forward-looking statement

Forecast of TEL's performance and future prospects and other sort of information published are made based on information available at the time of publication. Actual performance and results may differ significantly from the forecast described here due to changes in various external and internal factors, including the economic situation, semiconductor/FPD/PV market conditions, intensification of sales competition, safety and product quality management, and intellectual property-related risks.

Processing of numbers

For the amount listed, because fractions are rounded down, there may be the cases where the total for certain account titles does not correspond to the sum of the respective figures for account titles. Percentages are calculated using full amounts, before rounding.

Exchange Risk

In principle, export sales of Tokyo Electron's mainstay semiconductor and FPD/PV panel production equipment are denominated in yen. While some settlements are denominated in dollars, exchange risk is hedged as forward exchange contracts are made individually at the time of booking. Accordingly, the effect of exchange rates on profits is negligible.

FPD/PV: Flat panel display/Photovoltaic

